

# POWERTIP TECH. CORP.

DISPLAY DEVICES FOR BETTER ELECTRONIC DESIGN

# Specification For Approval

Model Type : <u>LCD Module</u>

Sample Code : PG12864ARS-ANN-J-S0

Mass Production Code : \_\_\_\_\_

Edition : 0

Customer Sign	Sales Sign	Approved By	Prepared By
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		90.5.W	90. 5. 14
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### **Display Start Line**

	R/W	D/I	DB7							.DB0
Code	0	0	1	1	A	A	A	A	A	A
			MSB							LSB

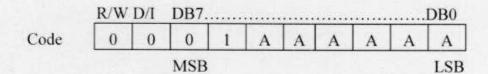
Z address AAAAA (binary) of the display data RAM is set in the display start line register and displayed at the top of the screen. Figure 1 shows examples of display (1/64 duty cycle) when the start line=0-3. When the display duty cycle is 1/64 or more (ex. 1/32, 1/24 etc.), the data of total line number of LCD screen, from the line specified by display start line instruction, is displayed. See figure 1.

### Set page (X address)

	R/W	R/W D/I DB7								DB0
Code	0	0	1	0	1	1	1	A	A	A
			MSB							LSE

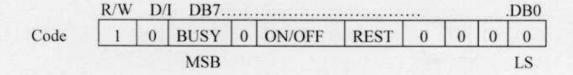
X address AAA (binary) of the display data RAM is set in the X address register. After that, writing or reading to or from MPU is executed in this specified page until the next page is set. See figure 2.

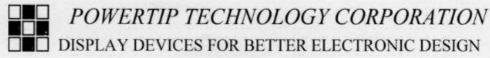
#### Set Y Address



Y address AAAAAA (binary) of the display data RAM is set in the Y address Counter. After that, Y address counter is increased by 1 every time the data is written or read to or from MPU.

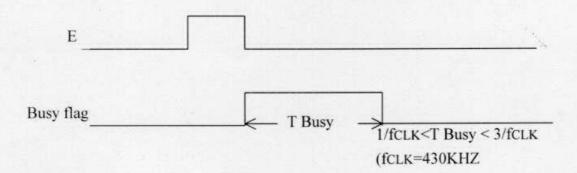
#### Status Read





#### · Busy

When busy is 1, the LSI is executing internal operations. No instructions are accepted while busy is 1, so you should make sure that busy is 0 before writing the next instruction.



#### · ON/OFF

Shows the liquid crystal display conditions: on condition or off condition.

When on/off is 1, the display is in off condition.

When on/off is 0, the display is in on condition.

#### RESET

RESET=1 shows that the system is being initialized. In this condition, no instructions except status read can be accepted.

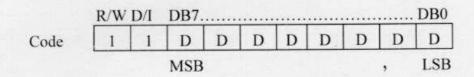
RESET=0 shows that initializing has finished and the system is in the usual operation condition.

### Write Display Data

			DB7	DB7						
Code	0	1	D	D	D	D	D	D	D	D
			MSE	3						LSB

Write 8-bit data DDDDDDDD (binary) into the display data RAM. Then Y address is increased by 1 automatically.

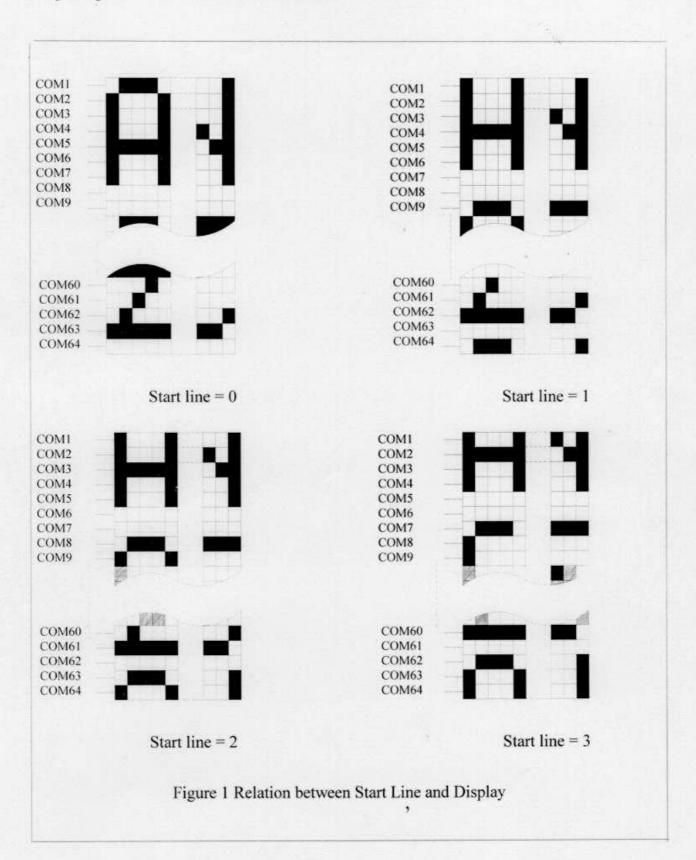
### Read Display Data





Reads out 8-bit data DDDDDDDD (binary) from the display data RAM. Then Y address is increased by 1 automatically.

One dummy read is necessary right after the address setting. For details, refer to the explanation of output register in "Function of Each Block".



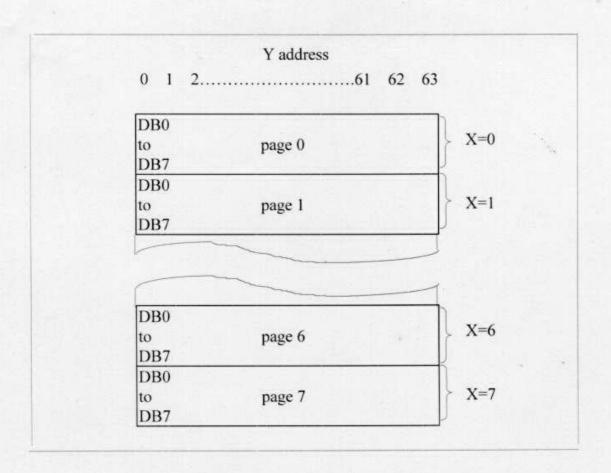
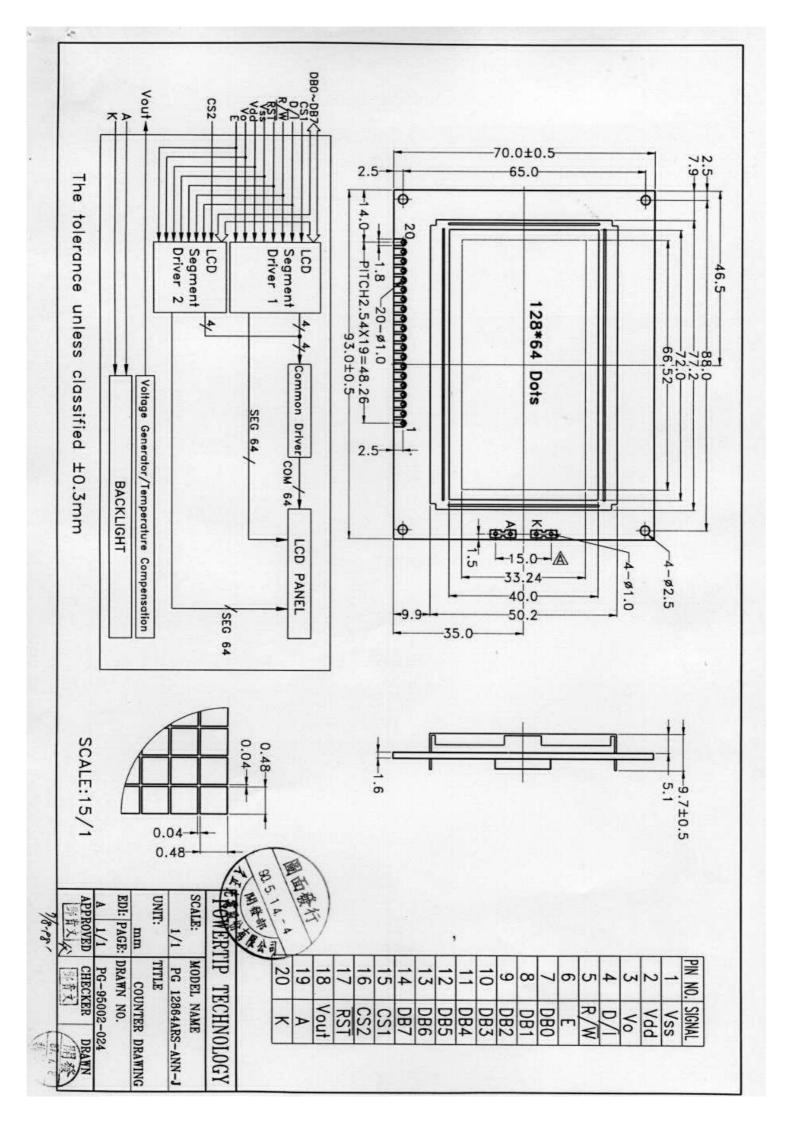


Figure 2 Address Configuration of Display Data RAM

Note: "128\*64" consist of 2 "64\*64"

CS1⇒ Chip enable for left 64\*64 (segment1 to segment 64)

CS2⇒ Chip enable for right 64\*64 (segment 65 to segment 128)



# Out Going Inspection Specification

Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II •

Defect Level: Major Defect AQL 0.65; Minor Defect AQL 1.0 •

Equipment: Gauge · MIL-STD · Powertip Tester · Sample ·

Specification:

ΝО	Item	Specification	Judge	Level
1	Part Number	Inconsistent with the P/N on the flow chart of production	N.G.	Major
2	Quantity	Inconsistent Q'TY with the flow chart of production	N.G.	Major
3	Electronic	Display short	N.G.	Major
	characteristics	Missing line	N.G.	Major
	10 100 100 100 100 100 100 100 100 100	Dot missing A > 1/2 Dot size	N.G.	Major
	$A=(L+W)\div 2$	No function	N.G.	Major
		Out put data error	N.G.	Major
4	Appearance	Material difference with flow chart	N.G.	Major
	The state of the s	LCD Assembled in opposite direction	N.G.	Major
	$A=(L+W)\div 2$	Bezel assembled in opposite direction	N.G.	Major
		Shadow within LCD V./A + 1.0 mm	N.G.	Major
	Dirty particle	Dirty particle A > 0.4 mm	N.G.	Minor
	(Include scratch · bubble)	Dirty particle length >3.0mm And 0.01mm < Width ≤0.05mm (Width>0.05mm	N.G.	Minor
		Measure by area )		
		Without protective film	N.G.	Minor
		Conductive rubber over bezel	N.G.	Minor
5	PCB Appearance	Burned PCB	N.G.	Major
		Solder mask A > 1.0mm	N.G.	Minor
	A=(L+W)÷ 2	(Finish coat not counted in)		
		A particle across the circuit	N.G	Minor
		Circuit split >1/2 Circuit width	N.G	Minor
		More than three solder ball /splashes 0.13mm or less per 600mm <sup>2</sup>	N.G	Minor

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Out Going Inspection Specification

### 1. SPECIFICATIONS

### 1.1 Features

- Full dot-matrix structure with 128 dots \*64 dots
- 1/64 Duty, 1/9 bias
- · STN LCD, positive, gray
- Reflective LCD
- 12 o'clock viewing angle
- 8 bits parallel data input ,without controller IC

### 1.2 Mechanical Specifications

Outline dimension : 93.0mm(L) \*70.0mm(W)\*10.2mm max.(H)

Viewing area : 72.0mm \*40.0mm
 Active area : 66.52mm \*33.24mm
 Dot size : 0.48mm \*0.48mm
 Dot pitch : 0.52mm \*0.52mm

### 1.3 Absolute Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit V	
Power supply Voltage	$V_{DD}$		4.5	5.5		
LCD drive Supply voltage	$V_{DD}$ - $V_{EE}$	-	8.0	17	V	
Input voltage	$V_{IN}$	-	-0.3	V <sub>DD</sub> +0.3	V	
Operating temperature	$T_{OPR}$	-	-20	70	°C	
Storage temperature	$T_{STG}$		-30	80	°C	
Humidity	HD			90	%RH	

### 1.4 DC Electrical Characteristics

 $V_{DD} = +5V + 10\%, V_{SS} = 0V, TA = 25$ °C

Item	Symbol	Condition	Min.	Тур.	Max.	Unit	
Logic Supply voltage	$V_{DD}$		4.5	5	5.5	V	
"H" input voltage	VIH		0.7V <sub>DD</sub>	•	VDD	V	
"L" input voltage	$V_{\rm IL}$		0	-	0.3V <sub>DD</sub>	V	
"H" output voltage	V <sub>OH</sub>		V <sub>DD</sub> -0.4		inia wit	V	
"L" output voltage	V <sub>OL</sub>	12	-	-	0.4	V	
Supply current	$I_{DD}$	V <sub>DD</sub> =5V	-	13	15.6	mA	
LCD driving voltage	$V_{OP}$	V <sub>DD</sub> -V <sub>O</sub>	,13.2	-	14.0	V	

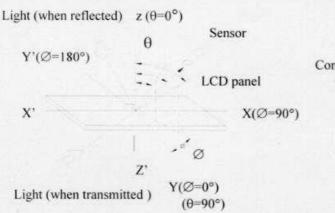
# 1.5 Optical Characteristics

1/128 duty, 1/12 bias, V<sub>OPR</sub>=14.0V, Ta=25°C

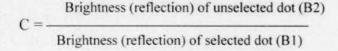
Item	Symbol	Conditions	Min.	Тур.	Max	Reference
Viewing angle	θ	C≥2.0,Ø=0°	30°	-	-	Notes 1 & 2
Contrast	C	θ=5°, Ø=0°		3		Note 3
Response time(rise)	Tr	θ=5°, Ø=0°	-	140ms	200ms	Note 4
Response time(fall)	$T_f$	θ=5°, Ø=0°		300ms	500ms	Note 4

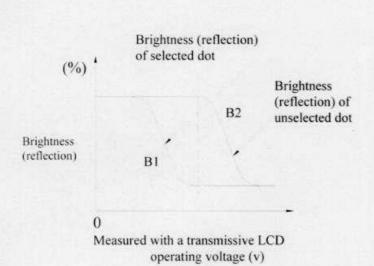
Parameter	Symbol	Tommoretune (9C)		Unit		
	Symbol	Temperature (°C)	Min	Тур	Max	Unit
Driving VOP	-20	14.3	14.7	15.1		
	V <sub>OP</sub>	25	13.2	13.6	14.0	V
		70	12.0	12.4	12.8	

### Note 1: Definition of angles $\theta$ and $\emptyset$

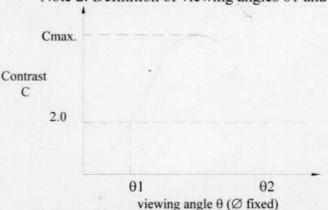


Note 3: Definition of contrast C



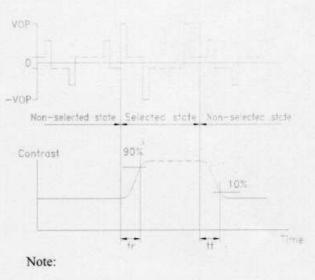


Note 2: Definition of viewing angles  $\theta 1$  and  $\theta 2$ 



Note: Optimum viewing angle with the naked eye and viewing angle θ at Cmax. Above are not always the same

Note 4: Definition of response time



panel which is displayed 1 cm2

V<sub>OPR</sub>: Operating voltage t<sub>r</sub>: Response time (rise) f<sub>FRM</sub>: Frame frequency t<sub>f</sub>: Response time (fall)

# 2. MODULE STRUCTURE

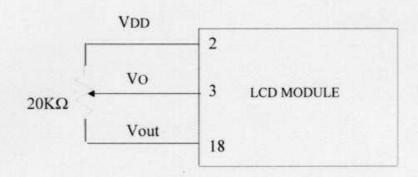
# 2.1 Counter Drawing

\*See Appendix 1

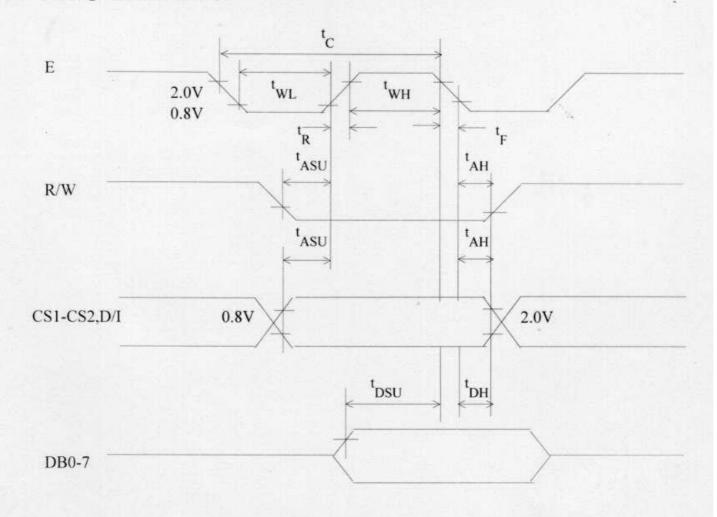
# 2.2 Interface Pin Description

Pin No.	Symbol	Function
1	$V_{SS}$	Power Supply (Vss=0)
2	$V_{DD}$	Power Supply (V <sub>DD</sub> >V <sub>SS</sub> )
3	$V_{O}$	Operating voltage for LCD
4	D/ I	Register selection input High =Data register Low =Instruction register (for write) Busy flag address counter (for read)
5	R/W	R/W signal input is used to select the read/write mode High =Read mode, Low =Write mode
6	E	Start enable signal to read or write the data
7-10	DB0~ DB3	Four low order bi-directional three-state data bus lines. Use for data transfer between the MPU and the LCD module. These four are not used during 4-bit operation.
11-14	DB4~ DB7	Four high order bi-directional three-state data bus lines. Used for data transfer between the MPU and the LCD module. DB7 can be used as a busy flag.
15	CS1	Chip enable for D2 (segment 1 to segment 64)
16	CS2	Chip enable for D3 (segment 65 to segment 128)
17	RST	Reset signal
18	Vout	Negative voltage output
19	A	Power supply for LED backlight (+)
20	K	Power supply for LED backlight (-)

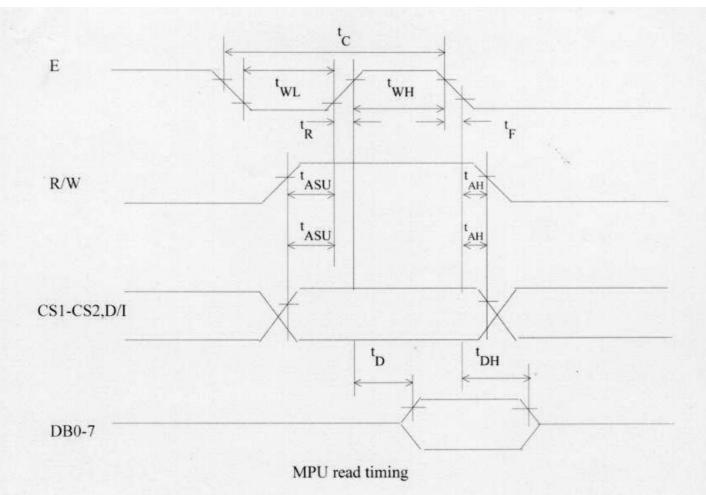
Contrast Adjust



# 2.3 Timing Characteristics



MPU write timing



Characteristic	Symbol	Min.	Тур	Max	Unit
E Cycle	t <sub>C</sub>	1000	-	-	ns
E High Level Width	t <sub>WH</sub>	450	-	-	ns
E Low Level Width	t <sub>WL</sub>	450	•	-	ns
E Rise Time	t <sub>R</sub>	8	-	25	ns
E Fall Time	t <sub>F</sub>	-	22	25	ns
Address Set-Up time	t <sub>ASU</sub>	140	-	-	ns
Address Hold Time	t <sub>AH</sub>	10	-	-	ns
Data Set-Up Time	t <sub>SU</sub>	200		-	ns
Data Delay Time	t <sub>D</sub>	-	-	320	ns
Data Hold Time (Write)	t <sub>DHW</sub>	10	-	-	ns
Data Hold Time (Read)	t <sub>DHR</sub>	20	-	-	ns

## 2.4 Display command

					Co	de					
	R/	D/I	DB7	DB	DB5	DB	DB	DB	DB	DB0	0
Instructions	W			6		4	3	2	1		Functions
Display on/off	0	0	0	0	1	1	1	1	1	1/0	Controls display on/off. RAM data and internal status are not affected.
Display start line	0	0	1	1	Disp	lay s	tart	line	(0-6	53)	Specifies the RAM line displayed at the top the screen.
Set Page (x address)	0	0	1	0	1	1	1	Pa	ge (	0-7)	Sets the page (X address) of RAM at the pag (X address) register.
Set Y address	0	0	0	1	Y ad	dres	s (0-	-63)			Sets the Y address in the Y address in the counter.
Status read	1	0	Busy	0	ON/ OFF	Res	set 0	0	0	0	Reads the status.  Reads 1: Reset 0: Normal ON/OFF 1: Display off 0: Display on Busy 1: Internal operation 0: Ready
Write display data	0	1	Writ	e da	ita						Writes data DB0 (LSB) Has access to the to DB7 (MSB) on the address of the data bus into display display RAM specified in
Read display data	1	1	Read	l dat	ta						Reads data DB0 (LSB) advance. After the display RAM to the data bus.

## Detailed Explanation Display On/Off

Code	R/W D/I		DB7							.DB0
	0	0	0	0	1	1	1	1	1	D
	MSB									LSB

The display data appears when D is 1 and disappears when D is 0. Though the data is not on the screen with D=0, it remains in the display data RAM. Therefore, you can make it appear by changing D=0 into D=1.



ΝО	Item	Specification		Level
6	Molding appearance	Too soft: Shape by touch changed		Major
	A=( L + W )÷ 2	Insufficient epoxy: IC circuit or IC pad visible		Minor
		Excessive epoxy: Diameter > 20mm Or High > 2.5mm		Minor
		Pin hole through to IC and A > 0.2mm	N.G.	Minor
7	Bezel appearance	Angle between frame and foot > 45° +10°		Minor
	A=( L + W )÷ 2	Electroplate strip A > 1.0mm ( Top view only )		Minor
		Rust (Top view only)		Minor
		Crack	N.G.	Minor
	Backlight electric	Error backlight color	N.G.	Major
	characteristics	No function	N.G.	Major
		Any LED dot no function	N.G.	Major
	A=( L + W )÷ 2	Solder connection of straight through termination does not meet minimum 270° circumferential fillet or wetting	N.G.	Minor
		0.5mm>lead protrusion >2.3mm	N.G.	Minor
9 L	LCD Appearance	Polarize rise over V/A		Minor
		Rainbow A > 1/3 bezel V/A	N.G.	Minor
10	Assembly parts	Solder fillet extends onto the component body		Minor
		Error position not in center D>1/2W	N.G.	Minor
	A=( L + W )÷ 2	W D D D D D D D D D D D D D D D D D D D		0
		End joint width is less than 50% land dewetting or no wetted joint	N.G.	Minor
		Component nick ,crack	N.G.	Minor